

Flavor Physics at The HL-LHC LHCb Upgrade II

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LHCb – A Forward Spectrometer @ LHC





LHCb Performance During Runs 1 & 2







Towards Upgrade II







Physics Reach of The Upgrade II



Key observables in flavor physics

Observable	Current LHCb	Upgı	rade I	Upgrade II	
	$(up to 9 fb^{-1})$	$(23{\rm fb}^{-1})$	$(50{\rm fb}^{-1})$	$(300{\rm fb}^{-1})$	
CKM tests					
$\gamma \ (B \rightarrow DK, \ etc.)$	4° [9,10]	1.5°	1°	0.35°	Lin and de litera
$\phi_s \ (B^0_s o J/\psi \phi)$	$32 \mathrm{mrad}$ [8]	$14\mathrm{mrad}$	$10\mathrm{mrad}$	$4\mathrm{mrad}$	Upgrade II w
$ V_{ub} / V_{cb} \ (\Lambda_b^0 \to p\mu^-\overline{\nu}_\mu, \ etc.)$	6% [29, 30]	3%	2%	1%	potential of th
$a^d_{ m sl} \ (B^0 o D^- \mu^+ u_\mu)$	$36 \times 10^{-4} [34]$	$8 imes 10^{-4}$	$5 imes 10^{-4}$	$2 imes 10^{-4}$	
$a_{ m sl}^s \ (B_s^0 o D_s^- \mu^+ u_\mu)$	$33 imes 10^{-4} [35]$	$10 imes 10^{-4}$	$7 imes 10^{-4}$	$3 imes 10^{-4}$	Further pursu
Charm					(spectroscopy
$\Delta A_{CP} \ (D^0 \to K^+ K^-, \pi^+ \pi^-)$	29×10^{-5} [5]	13×10^{-5}	8×10^{-5}	3.3×10^{-5}	dark sector
$A_{\Gamma} \ (D^0 \to K^+ K^-, \pi^+ \pi^-)$	11×10^{-5} [38]	5×10^{-5}	3.2×10^{-5}	1.2×10^{-5}	ions and fixed
$\Delta x \ (D^0 \to K^0_{\rm s} \pi^+ \pi^-)$	$18 \times 10^{-5} [37]$	$6.3 imes10^{-5}$	4.1×10^{-5}	$1.6 imes 10^{-5}$	
Rare Decays					
$\mathcal{B}(B^0 \to \mu^+ \mu^-) / \mathcal{B}(B^0_s \to \mu^+ \mu^-)$	$^{-})$ 69% [40, 41]	41%	27%	11%	
$S_{\mu\mu} \ (B^0_s \to \mu^+ \mu^-)$	—		_	0.2	Success of the
$A_{\rm T}^{(2)} \ (B^0 \to K^{*0} e^+ e^-)$	0.10 [52]	0.060	0.043	0.016	Success of the
$A_{\rm T}^{\rm Im} \left(B^0 \rightarrow K^{*0} e^+ e^- \right)$	0.10 [52]	0.060	0.043	0.016	□ HL-LHC pr
$\mathcal{A}^{\Delta\Gamma}_{\phi\gamma}(B^0_s o \phi\gamma)$	$^{+0.41}_{-0.44}$ [51]	0.124	0.083	0.033	Runs 5 and
$S_{\phi\gamma}(B^0_s \to \phi\gamma)$	0.32 [51]	0.093	0.062	0.025	
$\alpha_{\gamma}(\Lambda_{b}^{0} \to \Lambda \gamma)$	$^{+0.17}_{-0.29}$ [53]	0.148	0.097	0.038	A detector
Lepton Universality Tests	0.20				as the pres
$R_K (B^+ \to K^+ \ell^+ \ell^-)$	0.044 [12]	0.025	0.017	0.007	
$R_{K^*} (B^0 \to K^{*0} \ell^+ \ell^-)$	0.12 [61]	0.034	0.022	0.009	
$R(D^*) \ (B^0 \to D^{*-}\ell^+\nu_\ell)$	0.026 [62, 64]	0.007	0.005	0.002	

(Ref: LHCC-2021-012 and references therein

Upgrade II will fully realize the flavor physics potential of the HL-LHC.

Further pursue a broad physics programme (spectroscopy, high precision EW and Higgs, dark sector and other exotic search, heavy ions and fixed target).

Success of the physics programme relies on

- □ HL-LHC providing LHCb ~50 fb⁻¹/year during Runs 5 and 6.
- A detector with similar or better performance as the present one for Run 3.



Detector Challenge in Upgrade II





Improve granularity Better radiation hardness Use timing to distinguish vertices (high-pileup)

+ Better coverage for low momentum tracking







The Tracking System





4D Vertexing with Precision Timing

LHCb







VELO Upgrade II



- □ VELO Sensor R&D targets on timing (~50 ps), radiation hardness (max ~ $6 \times 10^{16} n_{eq}/cm^2$), and could incorporate thin planar, LGAD, 3D or new concepts.
- Candidates of 28 nm technology ASICs: VeloPix2 from TimePix4 (Picopix as a small demonstrator chip being developed), Timespot, …
- R&D on lightweight partially replaceable modules, thinner or no RF foil, robust 3D printed Titanium cooling substrate, …

	VeloPix (2016)	Timepix4 (2019)	Picopix++/4DPix ??					
Technology	130 nm	65 nm	28 nm					
Pixel Size	55 x 55 μm	55 x 55 μm	42/55 x 42/55 μm					
Pixel arrangement	3-side buttable 256 x 256	4-side buttable 512 x 448	4-side buttable 256 x 256					
Sensitive area	1.98 cm ²	6.94 cm ²	1.98 cm ²					
Event Packet	24 bit	64-bit	32-bit					
Max rate	~400 Mhits/cm ² /s	178.8 Mhits/cm ² /s	~ ~4000 Mhits/cm ² /s					
TDC bin width	25 ns	~200ps	~ ~30 ps					
Readout bandwidth	19.2 Gb/s	≤81.92 Gb/s	~ ~250 Gb/s					





MAPS Technology For UT & MT-CMOS





Monolithic Active Pixel Sensor (MAPS)

- UT & MT-CMOS both use the MAPS technology, which is very promising and cost effective for large area pixel detectors.
- It is advantageous for the two to use exactly the same chip design. However, small variations are possible due to different data rates, rad-hardness requirement, ...
- Very active design and test work towards the final chips.



MightyPix1 tested in a beam at DESY



Malta2 bench test at Saclay





7/7/2022

Mighty Tracker



Keep SciFi design at outer region **Micro-lens** Further away from beam Micro-lens on SiPM to enhance light collection. Cryogenic cooling for SiPM: $-40^{\circ}C \Rightarrow -120^{\circ}C$ **Cryogenic cooling** cryostat Vacuum box Cold plate Kapton flex cables SiPM Vacuum **HV-CMOS MAPS detector** feedthrough clear fibre interface 6 layers ,18 m² in total Interface to SciFi module Pixel size ~ $50 \times 150 \ \mu m^2$ Upgrade the inner-most at LS3.

SciFi operatiing at Run3 is upgraded to MT-SciFi + MT-CMOS





Magnet Stations











- □ To enhance the tracking capability, improve track reconstruction, particularly in the outer edges of SciFi acceptance and for low momentum tracks.
- □ Instrument walls of magnet with extruded triangular scintillating bars.
- Light collected by WS, guided through clear fibers to SiPMs outside magnet.
- □ It delivers sub-% momentum measurement precision.
- □ Significantly increase the acceptance of low momentum tracks, e.g. gain a factor of ~2 in prompt D^{*+} with slow π .
- □ The Magnet Stations could be installed at LS3.



Particle Identification Detectors









- RICH 1 & 2 will maintain same geometry, reduce pixel size using SiPM or MCP.
- Time-stamping each photon with high precision, which is crucial to PID performance.
- □ Test beam study of FastIC ASIC + external TDC.
- Design FastRICH based on FastIC with added features such as CFD, data compression and internal TDC.



1" & 2" MAPMT

SiPM array



Upgrade	Photon Detector	FE ASIC	Time Resolution	TimeStamp Precision
Ι	MAPMT	CLARO	~ 150 ps	3.125 ns
I.b*	MAPMT	FastRICH	~ 150 ps	25 ps
II	SiPM, MCP, MAPMT	FastRICH	< 100 ps	25 ps

* LS3 consolidation



TORCH Time of Flight Detector



- Brand new detector to enhance low momentum PID capabilities, improve background suppression and flavour tagging.
- Cherenkov photons produced by charged particles traversing quartz plane, then transported by total internal reflection to focusing block and detected with MCP-PMTs
- □ Measurement of Cherenkov angle, path length, and time of arrival.
- Aim for 10-15 ps resolution/track, needs ~30 photons, 70 ps/photon









5D Calorimetry with Precision Timing



- ✤ Key features: energy resolution ($10\%/\sqrt{E} \oplus 1\%$), radiation hardness (up to 1 MGy), timing capability (tens of ps) and granularity.
- Baseline: combination of technologies for different regions starting from the inner-most,
 - SpaCal W/GAGG
 - SpaCal Pb/Plastic Scintillator
 - Shashlik of different segmentations
- Possibility of adding timing layer: LAPPD or Si layers.
- Possibility of replacing the inner-most modules at LS3.

Region	Module type	Cell size	Segmentation	R_M	$\sigma_E/E = A/\sqrt{E} \oplus B$
		$[\mathrm{cm}^2]$	$[mm]/[X_0]$	[mm]	A/B [%]
1	SpaCal W/GAGG	1.5×1.5	45 + 105/70 + 180	14.5	9.1 / 1.4
2	SpaCal Pb/PS	3.0×3.0	80+210/70+180	29.5	$10.4 \ / \ 0.6$
3	Shashlik	4.0×4.0	Continuous fibres	35.0	10.0 / 1.0
4	Shashlik	6.0×6.0	Continuous fibres	35.0	10.0 / 1.0
5	Shashlik	12.0×12.0	Continuous fibres	35.0	10.0 / 1.0







Muon Detector





HCAL replace with Iron/concrete shield New µ-RWELL detector in the Inner region

removed in Upgrade I

- Novel μ -RWELL for the innermost region.
- Reuse existing MWPC in the outer region.
- □ Additional shielding $(6\lambda_I \rightarrow 10\lambda_I)$ will be installed in front of Muon detector, bring down the rate by a factor of ~ 2 .







Event-builder architecture for Upgrade II



- Novel trigger system for Upgrade I
 - Fully software trigger
 - HLT1 based on GPUs
- □ Similar concept planned for Upgrade II
 - Expected data throughput for real time analysis is ~ 200 Tb/s, (~ ×5 ATLAS or CMS after L0 at Upgrade II).
 - Further exploitation of hybrid architectures: CPU, GPU, FPGA...
- Offline computing requirements are significant
 - Upgrade I model not sustainable
 - Issues in Run 5 are similar to ATLAS & CMS Upgrade II of Run 4
 - Coordination with WLCG and the HEP Software Foundation on mitigation







- LHCb plans Upgrade II to fully exploit HL-LHC for flavor physics and beyond.
- The FTDR was approved. The upgrade entered the R&D phase, leading towards detector TDRs, construction, installation and eventually operation for physics.
- This is an ambitious major upgrade (~0.5 of a ATLAS/CMS Upgrade II detector). We are actively seeking new collaborators and will be happy to discuss with anyone interested.
- * There are a number of innovative technologies that can act as a bridge to those for future colliders.

	<02	<i>a</i>	2023	602 A	2025 25	<03	\$Q2	<029	²⁰²⁰	~2030	<03,	203- 203-	<033	<03	<035	•••	2047
Phase	LS	52	Run 3		LS 3		Run 4			LS 4		Run 5 & 6		6			
Project Approval Stages	FT	DR				MoU											
Detectors						TL	DR										
Online, Trigger, Computing									1	DR							
LS3 Infrastructure																	
LS3 Detector Construction							Ins	tall									
LS4 Detector Construction							Install										

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